



# N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$r_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A)		
30	0.057 @ V <sub>GS</sub> = 10 V	3.5		
	0.094 @ V <sub>GS</sub> = 4.5 V	2.8		

### **FEATURES**

- TrenchFET® Power MOSFET
- 100% R<sub>q</sub> Tested

TO-236 (SOT-23) G 1 S 2 Top View Si2306DS (A6)\* \*Marking Code

Ordering Information: Si2306DS-T1

ABSOLUTE MAXIMUM RATINGS ( $T_A = 25$ °C UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	V <sub>DS</sub>	30				
Gate-Source Voltage		V <sub>GS</sub>	±20			
Continuous Drain Current (T,I = 150°C) <sup>a, b</sup>	T <sub>A</sub> = 25°C	1-	3.5			
Continuous Diam Current (1) = 150 C) % 2	T <sub>A</sub> = 70°C	ID	2.8	Α		
Pulsed Drain Current		I <sub>DM</sub>	16			
Continuous Source Current (Diode Conduction) <sup>a, b</sup>		I <sub>S</sub>	1.25			
Mariana Dana Distriction h	T <sub>A</sub> = 25°C		1.25	14/		
Maximum Power Dissipation <sup>a, b</sup>	T <sub>A</sub> = 70°C	P <sub>D</sub>	0.80	W		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Na. drawar karaka ka Anaka ang	t ≤ 5 sec	6		100	- °C/W	
Maximum Junction-to-Ambient <sup>a</sup>	Steady State	R <sub>thJA</sub>	130			

### Notes

a. Surface Mounted on FR4 Board.

 $b. \quad t \leq 5 \text{ sec.}$ 

## Vishay Siliconix



Parameter	Symbol	<b>Test Condition</b>	Min	Тур	Max	Unit	
Static	l l		l	I	I	l	
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{DS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			v	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	1				
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ = $\pm 20$ V			± 100	nA	
7 0	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			0.5	0.5 10 μA	
Zero Gate Voltage Drain Current		$V_{DS}$ = 30 V, $V_{GS}$ = 0 V, $T_{J}$ = 55°C			10		
0.01.1.0.10		$V_{DS} \ge 4.5 \text{ V}, V_{GS} = 10 \text{ V}$	6			1	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \geq$ 4.5 V, $V_{GS}$ = 4.5 V	4			Α	
Drain-Source On-State Resistance <sup>a</sup>		$V_{GS} = 10 \text{ V}, I_D = 3.5 \text{ A}$		0.046	0.057	1_	
	r <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 2.8 A		0.070	0.094	Ω	
Forward Transconductancea	9fs	$V_{DS} = 4.5 \text{ V}, I_D = 3.5 \text{ A}$		6.9		S	
Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>S</sub> = 1.25 A, V <sub>GS</sub> = 0 V		0.8	1.2	V	
Dynamic <sup>b</sup>							
Gate Charge	Qg	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 5 V, I <sub>D</sub> = 3.5 A		4.2	7		
Total Gate Charge	Q <sub>gt</sub>			8.5	20	nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, \ V_{GS} = 10 \text{ V}, \ I_D = 3.5 \text{ A}$		1.9			
Gate-Drain Charge	$Q_{gd}$			1.35			
Gate Resistance	$R_g$		0.5		2.4	Ω	
Input Capacitance	C <sub>iss</sub>			555			
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		120		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			60		1	
Switching							
Turn-On Delay Time	t <sub>d(on)</sub>			9	20		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 15 $\Omega$		7.5	18	1	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_G = 6 \Omega$		17	35	ns	
Fall Time	t <sub>f</sub>			5.2	12	1	

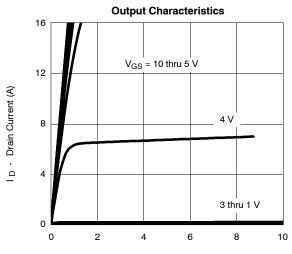
 $<sup>\</sup>begin{tabular}{ll} Notes \\ a. & Guaranteed by design, not subject to production testing. \\ b. & Pulse test; pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$. \\ \end{tabular}$ 

5

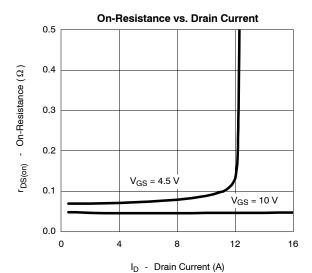


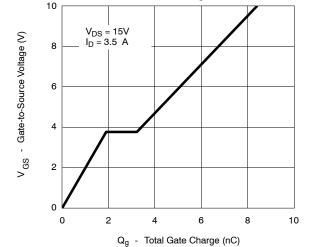


### TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

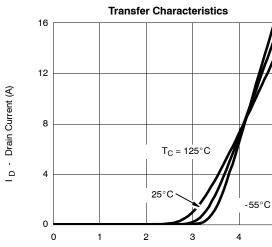


 $V_{\mbox{\footnotesize DS}}\,$  -  $\,$  Drain-to-Source Voltage (V)

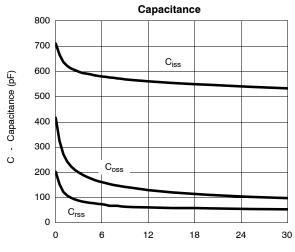




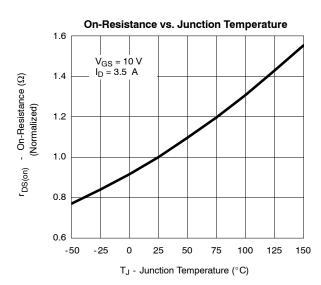
**Gate Charge** 



 $V_{GS}\,$  - Gate-to-Source Voltage (V)



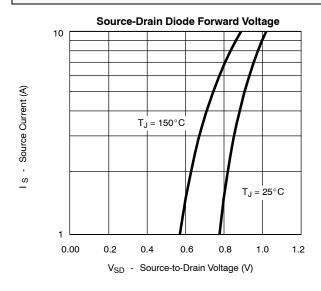
V<sub>DS</sub> - Drain-to-Source Voltage (V)

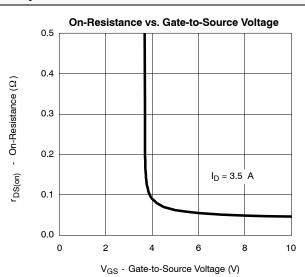


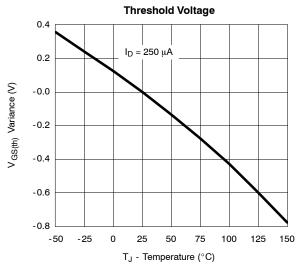
## **Vishay Siliconix**

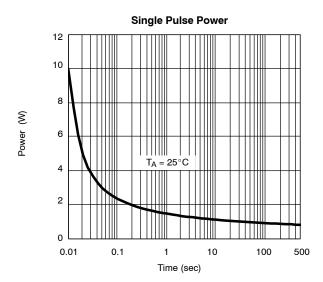


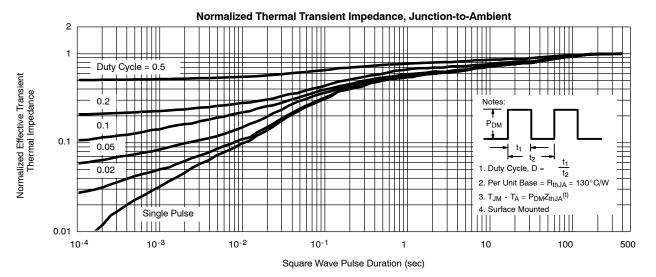
### TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)













Vishay

### **Disclaimer**

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.

Document Number: 91000 Revision: 18-Jul-08

www.vishay.com